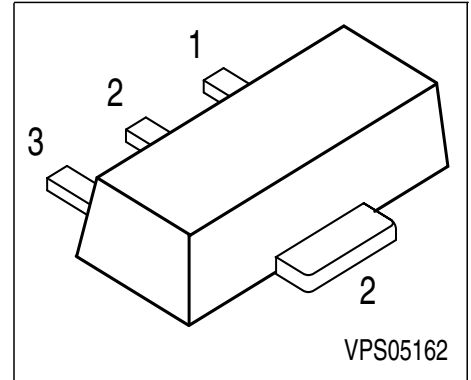


NPN Silicon AF Transistors

- For AF driver and output stages
- High collector current
- Low collector-emitter saturation voltage
- Complementary types: BCX 51 ... BCX 53 (PNP)



Type	Marking	Pin Configuration			Package
BCX 54	BA	1 = B	2 = C	3 = E	SOT-89
BCX 54-10	BC	1 = B	2 = C	3 = E	SOT-89
BCX 54-16	BD	1 = B	2 = C	3 = E	SOT-89
BCX 55	BE	1 = B	2 = C	3 = E	SOT-89
BCX 55-10	BG	1 = B	2 = C	3 = E	SOT-89
BCX 55-16	BM	1 = B	2 = C	3 = E	SOT-89
BCX 56	BH	1 = B	2 = C	3 = E	SOT-89
BCX 56-10	BK	1 = B	2 = C	3 = E	SOT-89
BCX 56-16	BL	1 = B	2 = C	3 = E	SOT-89

Maximum Ratings

Parameter	Symbol	BCX 54	BCX 55	BCX 56	Unit
Collector-emitter voltage	V_{CEO}	45	60	80	V
Collector-base voltage	V_{CBO}	45	60	100	
Emitter-base voltage	V_{EBO}	5	5	5	
DC collector current	I_C	1			A
Peak collector current	I_{CM}	1.5			
Base current	I_B	100			mA
Peak base current	I_{BM}	200			
Total power dissipation, $T_S = 130\text{ °C}$	P_{tot}	1			W
Junction temperature	T_j	150			°C
Storage temperature	T_{stg}	-65 ... 150			

Thermal Resistance

Junction ambient ¹⁾	R_{thJA}	≤75			K/W
Junction - soldering point	R_{thJS}	≤20			

1) Package mounted on pcb 40mm x 40mm x 1.5mm / 6cm² Cu

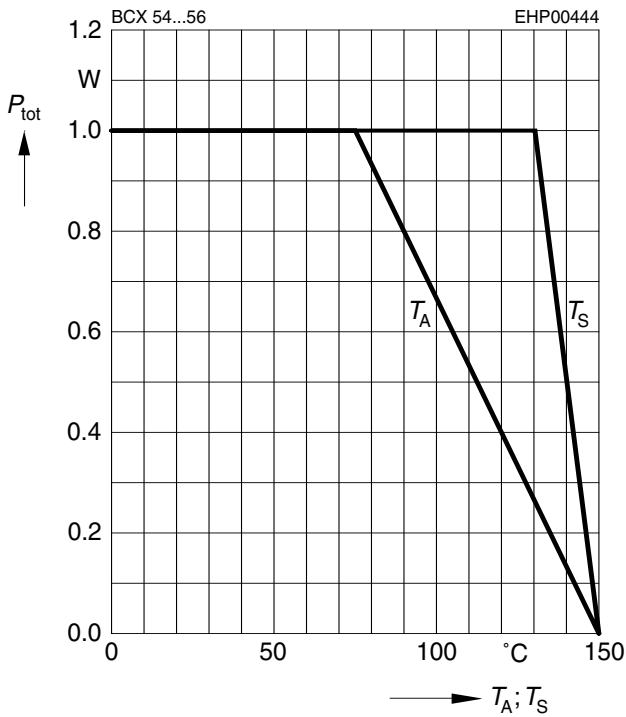
Electrical Characteristics at $T_A = 25^\circ\text{C}$, unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC Characteristics					
Collector-emitter breakdown voltage $I_C = 10\text{ mA}, I_B = 0$	$V_{(BR)CEO}$				V
BXP 54		45	-	-	
BXP 55		60	-	-	
BXP 56		80	-	-	
Collector-base breakdown voltage $I_C = 100\ \mu\text{A}, I_B = 0$	$V_{(BR)CBO}$				
BXP 54		45	-	-	
BXP 55		60	-	-	
BXP 56		100	-	-	
Emitter-base breakdown voltage $I_E = 10\ \mu\text{A}, I_C = 0$	$V_{(BR)EBO}$	5	-	-	
Collector cutoff current $V_{CB} = 30\text{ V}, I_E = 0$	I_{CBO}	-	-	100	nA
Collector cutoff current $V_{CB} = 30\text{ V}, I_E = 0, T_A = 150^\circ\text{C}$	I_{CBO}	-	-	20	μA
DC current gain 1) $I_C = 5\text{ mA}, V_{CE} = 2\text{ V}$	h_{FE}	25	-	-	-
DC current gain 1) $I_C = 150\text{ mA}, V_{CE} = 2\text{ V}$	h_{FE}				-
BCX54...56		40	-	250	
hFE-grp. 10		63	100	160	
hFE-grp. 16		100	160	250	
DC current gain 1) $I_C = 500\text{ mA}, V_{CE} = 2\text{ V}$	h_{FE}	25	-	-	-
Collector-emitter saturation voltage1) $I_C = 500\text{ mA}, I_B = 50\text{ mA}$	V_{CEsat}	-	-	0.5	V
Base-emitter voltage 1) $I_C = 500\text{ mA}, V_{CE} = 2\text{ V}$	$V_{BE(ON)}$	-	-	1	
AC Characteristics					
Transition frequency $I_C = 50\text{ mA}, V_{CE} = 10\text{ V}, f = 20\text{ MHz}$	f_T	-	100	-	MHz

 1) Pulse test: $t \leq 300\ \mu\text{s}$, $D = 2\%$

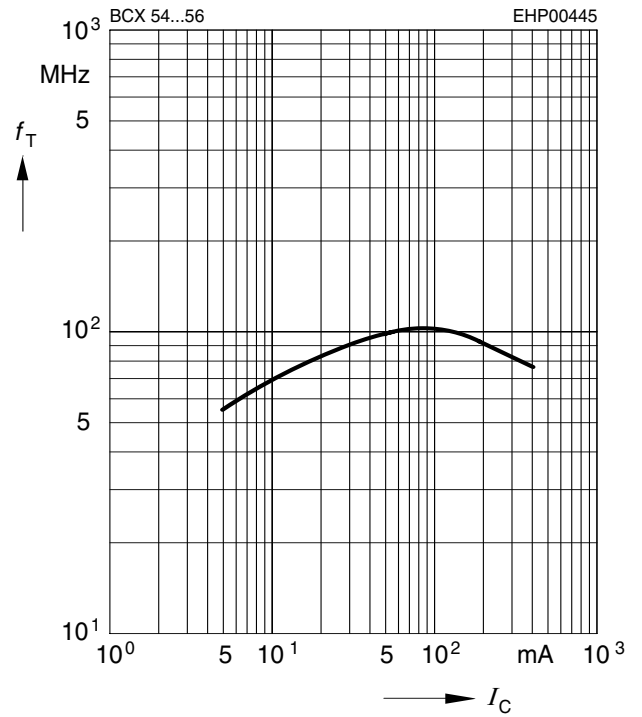
Total power dissipation $P_{tot} = f(T_A^*; T_S)$

* Package mounted on epoxy



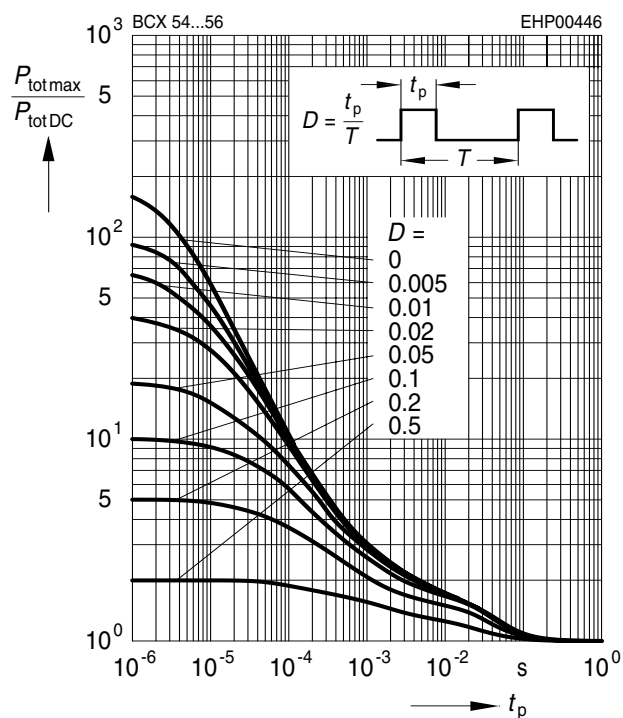
Transition frequency $f_T = f(I_C)$

$V_{CE} = 10V$



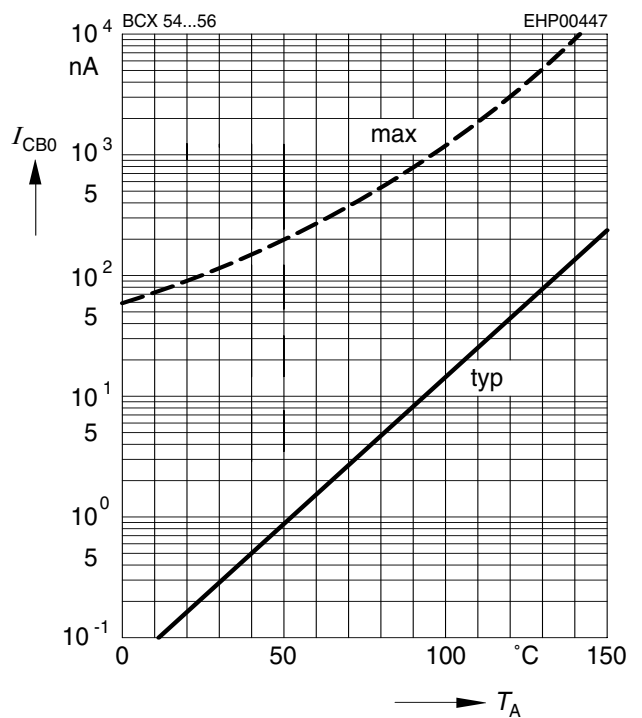
Permissible pulse load

$P_{totmax} / P_{totDC} = f(t_p)$



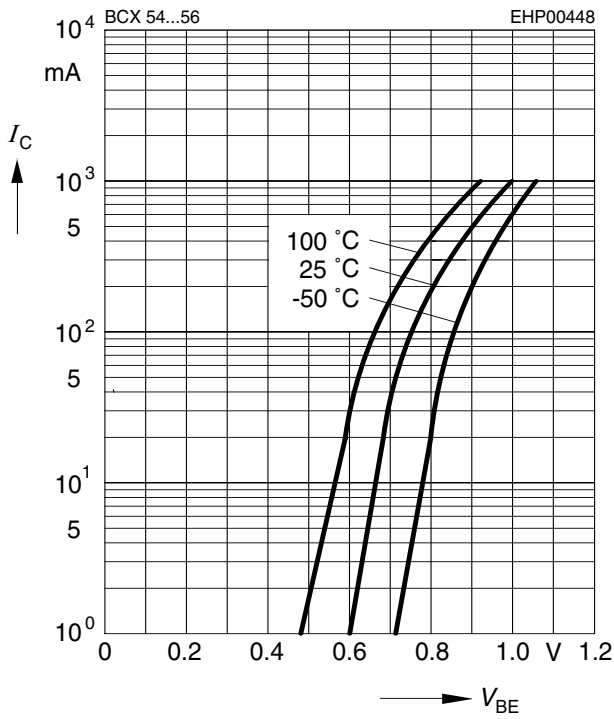
Collector cutoff current $I_{CBO} = f(T_A)$

$V_{CB} = 30V$



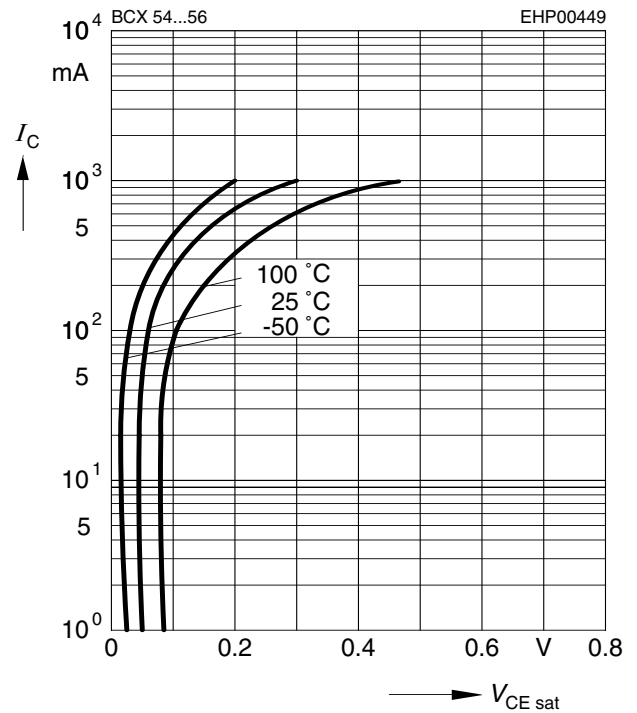
Collector current $I_C = f(V_{BE})$

$V_{CE} = 2V$



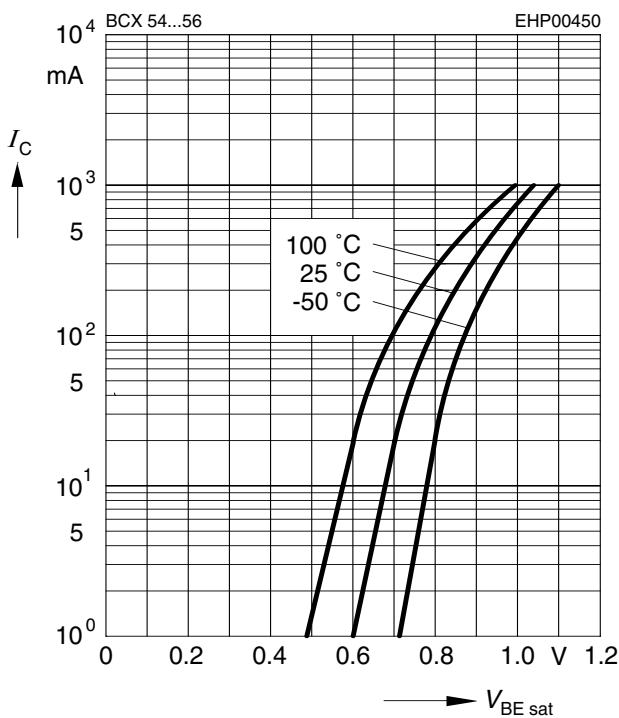
Collector-emitter saturation voltage $I_C = f(V_{CEsat}), h_{FE} = 10$

$I_C = f(V_{CEsat}), h_{FE} = 10$



Base-emitter saturation voltage $I_C = f(V_{BEsat}), h_{FE} = 10$

$I_C = f(V_{BEsat}), h_{FE} = 10$



DC current gain $h_{FE} = f(I_C)$

$V_{CE} = 2V$

